















Software

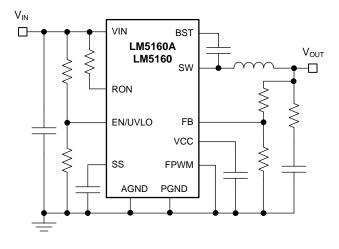
LM5160, LM5160A

JAJSGD5E - OCTOBER 2014-REVISED OCTOBER 2018

# LM5160、LM5160A 入力範囲の広い65V、2A同期整流降圧/ Fly-Buck™ DC/DCコンバータ

## 1 特長

- 4.5V~65Vの広い入力電圧範囲
- ハイサイド/ローサイド・スイッチ内蔵
  - 外付けショットキー・ダイオードが不要
- 最大2Aの負荷電流
- 適応型コンスタント・オンタイム制御
  - 外部ループ補償不要
  - 高速過渡応答
- 強制PWMまたはDCM動作を選択可能
  - FPWMによるマルチ出力 Fly-Buck™
- ほぼ一定のスイッチング周波数
  - 抵抗により最高1MHzに設定可能
- ソフトスタート時間をプログラム可能
- プリバイアス付きスタートアップ
- ±1%の帰還基準電圧
- LM5160Aは外部のV<sub>CC</sub>バイアスを使用可能
- 本質的な保護機能による堅牢な設計
  - ピーク電流制限保護
  - 入力UVLOおよびヒステリシスを調整可能
  - VCCおよびゲート・ドライブのUVLO保護
  - ヒステリシス付きのサーマル・シャットダウン保護
- WEBENCH® Power Designerにより、LM5160A を使用するカスタム設計を作成 代表的な同期整流降圧アプリケーション回路



## 2 アプリケーション

- 産業用プログラマブル・ロジック・コントローラ
- IGBTゲート・ドライブのバイアス電源
- テレコムの1次側/2次側バイアス
- Eメーター用電力線通信
- 低消費電力の絶縁DC/DC (Fly-Buck)

## 3 概要

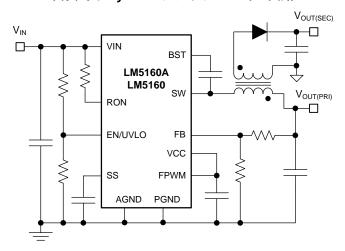
LM5160/Aは65V、2Aの同期整流降圧コンバータで、ハイサイドとローサイドのMOSFETが内蔵されています。適応型コンスタント・オンタイム制御方式はループ補償が必要なく、高い降圧比と高速な過渡応答を実現できます。内部のフィードバック・アンプにより、動作温度範囲の全体にわたって出力電圧を±1%にレギュレートします。オン時間は入力電圧に反比例し、結果としてスイッチング周波数はほぼ一定になります。

## 製品情報<sup>(1)</sup>

型番	パッケージ	本体サイズ(公称)
LM5160A	\\\CON (42\)	4.00,000,004.00,000
LM5160	WSON (12)	4.00mm×4.00mm

(1) 提供されているすべてのパッケージについては、巻末の注文情報を参照してください。

## 代表的なFly-Buckアプリケーション回路





# 目次

1	特長 1	9 Application and Implementation	17
2	アプリケーション1	9.1 Application Information	
3	概要1	9.2 Typical Applications	
4	改訂履歴	9.3 Do's and Don'ts	27
5	概要(続き)4	10 Power Supply Recommendations	28
6	Pin Configuration and Functions 5	11 Layout	
7	Specifications 6	11.1 Layout Guidelines	
'	7.1 Absolute Maximum Ratings	11.2 Layout Example	29
	7.2 ESD Ratings	12 デバイスおよびドキュメントのサポート	30
	7.3 Recommended Operating Conditions	12.1 デバイス・サポート	30
	7.4 Thermal Information	12.2 ドキュメントのサポート	30
	7.5 Electrical Characteristics	12.3 関連リンク	31
	7.6 Switching Characteristics	12.4 ドキュメントの更新通知を受け取る方法	31
	7.7 Typical Characteristics	12.5 コミュニティ・リソース	31
8	Detailed Description	12.6 商標	31
٠	8.1 Overview	12.7 静電気放電に関する注意事項	32
	8.2 Functional Block Diagram	12.8 Glossary	32
	8.3 Feature Description	13 メカニカル、パッケージ、および注文情報	32
	8.4 Device Functional Modes		
	5 255 . d		

# 4 改訂履歴

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

Revision D (November 2017) から Revision E に変更	Revision D (November 2017) から Revision E に変更	
<ul><li>「特長」変更</li></ul>		
• 「概要」変更		
<ul><li>表紙の回路図 変更</li></ul>		
Changed Pinout Drawing		
Changed Function Block Diagram		
Changed Power Supply Recommendations		28
<ul><li>変更 関連資料</li></ul>		30

Re	evision C (August 2016) から Revision D に変更	Page
•	データシートにWEBENCHへのリンクを 追加	1
•	Deleted the lead temperature from the Absolute Maximum Ratings table	6
•	Changed the Ripple Configuration section to the Application Information section	17
•	Changed the Application Performance Plots title to Application Curves in both typical application sections	22
•	変更「静電放電に関する警告」声明	31

Re	evision B (July 2015) から Revision C に変更	Page
•	タイトルの全負荷定格を1.5Aから2Aに 変更	
•	全負荷定格を1.5Aから2Aに 変更	
•	全負荷定格を1.5Aから2Aに 変更	
•	最新のドキュメントおよび翻訳基準に合わせて、データシートのテキストを更新	
•	Changed recommended output current rating from 1.5-A to 2-A	
•	Changed full load rating from 1.5 A to 2 A	12



## www.tij.co.jp

•	Changed minimum ripple injection equation	17
•	Deleted 'maximum' from the sentence	18
•	Deleted 'maximum' from the sentence	19
•	Deleted 'maximum' from the sentence	20
•	Changed equation for the required primary output voltage	25
•	Changed equation to add the isolated output voltage detail	25
Re	evision A (January 2015) から Revision B に変更	Page
•	Changed the input capacitor calculation equation	21
20	014年10月発行のものから更新	Page
•	ファミリをデータシートに 追加	1
•	図の型番に <b>"A"</b> を 追加	1
•	Changed Handling Ratings to ESD Ratings	6
•	Added Ext VCC recommended operating data for LM5160A	6
•	Added conditions for LM5160A	7
•	Added Ext- VCC description for LM5160A	13
•	Added Application circuit with LM5160A	27
•	Added Don'ts with LM5160	27
•	Added updated layout guidelines with LM5160A	29
•	Added updated layout diagram	29
•	追加 関連資料	30



## 5 概要(続き)

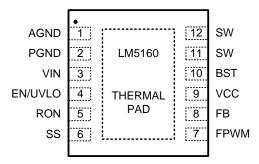
ピークおよびバレー電流制限回路により、過負荷状況から保護されます。低電圧誤動作防止(EN/UVLO)回路では、入力の低電圧スレッショルドとヒステリシスを別々に調整できます。LM5160/AはFPWMピンにより、無負荷から全負荷までの全域で連続導通モード(CCM)で動作するか、または軽負荷時に効率を上げるため自動的に不連続導通モード(DCM)に切り替わるようにプログラムされます。強制CCM動作では、複数の出力と、結合インダクタを使用する絶縁Fly-Buckアプリケーションがサポートされます。

LM5160AとLM5160は、特長およびピン構成が同一です。降圧およびFly-Buckアプリケーションでは、LM5160AのVCC ピンに外部バイアス電源を接続できます。この追加機能により、ICの消費電力が減少し、高い入力電圧での効率が向上します。



# 6 Pin Configuration and Functions

## DNT Package 12-Pin WSON With Exposed Thermal Pad Top View



#### **Pin Functions**

	PIN	I/O <sup>(1)</sup>	DESCRIPTION	
NO.	NAME	1/0(1)	DESCRIPTION	
1	AGND	_	Analog Ground. Ground connection of internal control circuits.	
2	PGND	Р	Power Ground. Ground connection of the internal synchronous rectifier FET.	
3	VIN	Р	Input supply connection. Operating input range is 4.5 V to 65 V.	
4	EN/UVLO	I	Precision enable. Input pin of undervoltage lockout (UVLO) comparator.	
5	RON I On-time programming pin. A resistor between this pin and VIN sets the switch on-time as a function of input voltage.			
6	SS	I	Soft start. Connect a capacitor from SS to AGND to control output rise time and limit overshoot.	
7	FPWM I Forced PWM logic input pin. Connect to AGND for discontinuous conduction mode (DCM) with light loads. Connect to VCC for continuous conduction mode (CCM) at all loads and Fly-Buck configuration.			
8	FB	I	Feedback input of voltage regulation comparator.	
9	VCC	0	Internal high voltage start-up regulator bypass capacitor pin.	
10	BST	Р	Bootstrap capacitor pin. Connect a capacitor between BST and SW to bias gate driver of high-side buck FET.	
11,12	SW	Р	Switch node. Source connection of high-side buck FET and drain connection of low-side synchronous rectifier FET.	
_	NC	_	No Connection.	
_	EP	_	Exposed Pad. Connect to AGND and printed-circuit board ground plane to improve power dissipation.	

<sup>(1)</sup> P = Power, G = Ground, I = Input, O = Output.



## 7 Specifications

## 7.1 Absolute Maximum Ratings

Over the recommended operating junction temperature of -40°C to 125°C (unless otherwise noted). (1)(2)

1 0,		MIN	MAX	UNIT
	VIN to AGND	-0.3	70	-
	EN/UVLO to AGND	-0.3	70	
	RON to AGND	-0.3	70	
lanut valtana	BST to AGND	-0.3	84	V
input voitages	VCC to AGND	-0.3	14	V
	FPWM to AGND	-0.3	14	
	SS to AGND	-0.3	7	
	FB to AGND	-0.3	7	
	BST to SW	-0.3	14	
Output valta as a	BST to VCC		70	V
Input voltages  Output voltages  Operating junction temperature, T <sub>J</sub> <sup>(3)</sup> Storage temperature, T <sub>stg</sub>	SW to AGND	-1.5	70	V
	SW to AGND (20-ns transient)	-3		
Operating junction temperature, T <sub>J</sub> <sup>(3)</sup>		-40	150	°C
Storage temperature, T <sub>stg</sub>		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## 7.2 ESD Ratings

			VALUE	UNIT
	Electrostatic	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±2000	\/
V <sub>(ESD)</sub>	discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	±750	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

## 7.3 Recommended Operating Conditions

Over the recommended operating junction temperature of -40°C to 125°C (unless otherwise noted). (1)

	MIN	MAX	UNIT
V <sub>IN</sub> input voltage	4.5	65	V
I <sub>OUT</sub> output current		2	Α
External V <sub>CC</sub> bias voltage (LM5160A only)	9	13	V
Operating junction temperature	-40	125	°C

<sup>(1)</sup> Recommended Operating Ratings are conditions under the device is intended to be functional. For specifications and test conditions, see Electrical Characteristics.

<sup>(2)</sup> If Military/Aerospace specified devices are required, contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

<sup>(3)</sup> High junction temperatures degrade operating lifetimes. Operating lifetime is derated for junction temperatures greater than 125°C.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



## 7.4 Thermal Information

		LM5160, LM5160A		
	THERMAL METRIC <sup>(1)</sup>	DNT (WSON)	UNIT	
		12 PINS		
$R_{\theta JA}$	Junction-to-ambient thermal resistance <sup>(1)</sup>	33.4	°C/W	
$R_{\theta JCbot}$	Junction-to-case (bottom) thermal resistance (1)	1.9	°C/W	
ΨЈВ	Junction-to-board thermal characteristic parameter	11.3	°C/W	
$R_{\theta JB}$	Junction-to-board thermal resistance	11.1	°C/W	
$R_{\theta JCtop}$	Junction-to-case (top) thermal resistance	24.7	°C/W	
ΨJT	Junction-to-top thermal characteristic parameter	0.2	°C/W	

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics report.

#### 7.5 Electrical Characteristics

Typical values correspond to  $T_J$  = 25°C. Minimum and maximum limits apply over  $T_J$  = -40°C to 125°C. Unless otherwise stated,  $V_{IN}$  = 24  $V_{.}^{(1)(2)}$ 

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SUPPLY CUI	RRENT				1	
I <sub>SD</sub>	Input shutdown current	V <sub>IN</sub> = 24 V, V <sub>EN/UVLO</sub> = 0 V		50	90.7	μA
I <sub>OP</sub>	Input operating current	V <sub>IN</sub> = 24 V, V <sub>FB</sub> = 3 V, non-switching		2.3	2.84	mA
VCC SUPPLY	Υ					
V <sub>CC</sub>	Bias regulator output	$V_{IN} = 24 \text{ V}, I_{CC} = 20 \text{ mA}$	6.47	7.5	8.52	V
V <sub>CC</sub>	Bias regulator current limit	V <sub>IN</sub> = 24 V	30			mΑ
V <sub>CC(UV)</sub>	VCC undervoltage threshold	V <sub>VCC</sub> rising		3.98	4.1	V
V <sub>CC(HYS)</sub>	VCC undervoltage hysteresis	V <sub>VCC</sub> falling		185		mV
V <sub>CC(LDO)</sub>	VIN – VCC dropout voltage	$V_{IN} = 4.5 \text{ V}, I_{VCC} = 20 \text{ mA}$		165	260	mV
HIGH-SIDE F	ET				•	
R <sub>DS(ON)</sub>	High-side on-state resistance	$V_{BST} - V_{SW} = 7 \text{ V}, I_{SW} = 1 \text{ A}$		0.29		Ω
BST <sub>(UV)</sub>	Bootstrap gate drive UV	V <sub>BST</sub> – V <sub>SW</sub> rising		2.93	3.6	V
BST <sub>(HYS)</sub>	Gate drive UV hysteresis	V <sub>BST</sub> – V <sub>SW</sub> falling		200		mV
LOW-SIDE F	ET					
R <sub>DS(ON)</sub>	Low-side on-state resistance	I <sub>SW</sub> = 1 A		0.13		Ω
HIGH-SIDE C	CURRENT LIMIT					
I <sub>LIM (HS)</sub>	High-side current limit threshold		2.125	2.5	2.875	Α
T <sub>RES</sub>	Current limit response time	I <sub>LIM (HS)</sub> threshold detect to FET turnoff		100		ns
T <sub>OFF1</sub>	Current limit forced off-time	$V_{FB} = 0 \text{ V}, V_{IN} = 65 \text{ V}$	17.31	29	39.8	μs
T <sub>OFF2</sub>	Current limit forced off-time	$V_{FB} = 1 \text{ V}, V_{IN} = 24 \text{ V}$	2.18	3.5	5.12	μs
LOW-SIDE C	URRENT LIMIT					
I <sub>SOURCE(LS)</sub>	Sourcing current limit		1.9	2.5	3	Α
I <sub>SINK(LS)</sub>	Sinking current limit			5.4		Α
DIODE EMUL	LATION					
$V_{FPWM(LOW)}$	FPWM input logic low	V <sub>IN</sub> = 24 V			1	V
V <sub>FPWM(HIGH)</sub>	FPWM input logic high	V <sub>IN</sub> = 24 V	3			V
I <sub>ZX</sub>	Zero cross detect current	FPWM = AGND (diode emulation)		0		mA
REGULATIO	N COMPARATOR					
V <sub>REF</sub>	FB regulation level	V <sub>IN</sub> = 24 V	1.977	2	2.017	V
I <sub>(Bias)</sub>	FB input bias current	V <sub>IN</sub> = 24 V			100	nA

<sup>(1)</sup> All minimum and maximum limits are specified by correlating the electrical characteristics to process and temperature variations and applying statistical process control.

<sup>(2)</sup> The junction temperature ( $T_J$  in °C) is calculated from the ambient temperature ( $T_A$  in °C) and power dissipation ( $P_D$  in Watts) as follows:  $T_J = T_A + (P_D \cdot R_{\theta JA})$  where  $R_{\theta JA}$  (in °C/W) is the package thermal impedance provided in Thermal Information.



## **Electrical Characteristics (continued)**

Typical values correspond to  $T_J$  = 25°C. Minimum and maximum limits apply over  $T_J$  = -40°C to 125°C. Unless otherwise stated,  $V_{IN}$  = 24 V. (1)(2)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ERROR CO	RRECTION AMPLIFIER and SOFT	START				
G <sub>M</sub>	Error amp transconductance	V <sub>FB</sub> = V <sub>REF</sub> ± 10 mV		105		μA/V
I <sub>EA(Source)</sub>	Error amp source current	V <sub>FB</sub> = 1 V, V <sub>SS</sub> = 1 V	7.62	10.2	12.51	μΑ
I <sub>EA(Sink)</sub>	Error amp sink current	V <sub>FB</sub> = 5 V, V <sub>SS</sub> = 2.25 V	7.46	10	12.2	μΑ
V <sub>(SS-FB)</sub>	V <sub>SS</sub> – V <sub>FB</sub> clamp voltage	V <sub>FB</sub> = 1.75 V, C <sub>SS</sub> = 1 nF		135		mV
I <sub>SS</sub>	Soft-start charging current	V <sub>SS</sub> = 0.5 V	7.63	10.2	12.5	μΑ
ENABLE/UV	/LO		•		·	
V <sub>UVLO (TH)</sub>	UVLO threshold	V <sub>EN/UVLO</sub> rising	1.213	1.24	1.277	V
I <sub>UVLO(HYS)</sub>	UVLO hysteresis current	V <sub>EN/UVLO</sub> = 1.4 V	15	20	25	μΑ
V <sub>SD(TH)</sub>	Shutdown mode threshold	V <sub>EN/UVLO</sub> falling	0.28	0.35		V
V <sub>SD(HYS)</sub>	Shutdown threshold hysteresis	V <sub>EN/UVLO</sub> rising		47		mV
	SHUTDOWN					
T <sub>SD</sub>	Thermal shutdown threshold			175		°C
T <sub>SD(HYS)</sub>	Thermal shutdown hysteresis			20		°C

## 7.6 Switching Characteristics

Typical values correspond to  $T_J$  = 25°C. Minimum and maximum limits apply over  $T_J$  = -40°C to 125°C. Unless otherwise stated,  $V_{IN}$  = 24 V.<sup>(1)</sup>

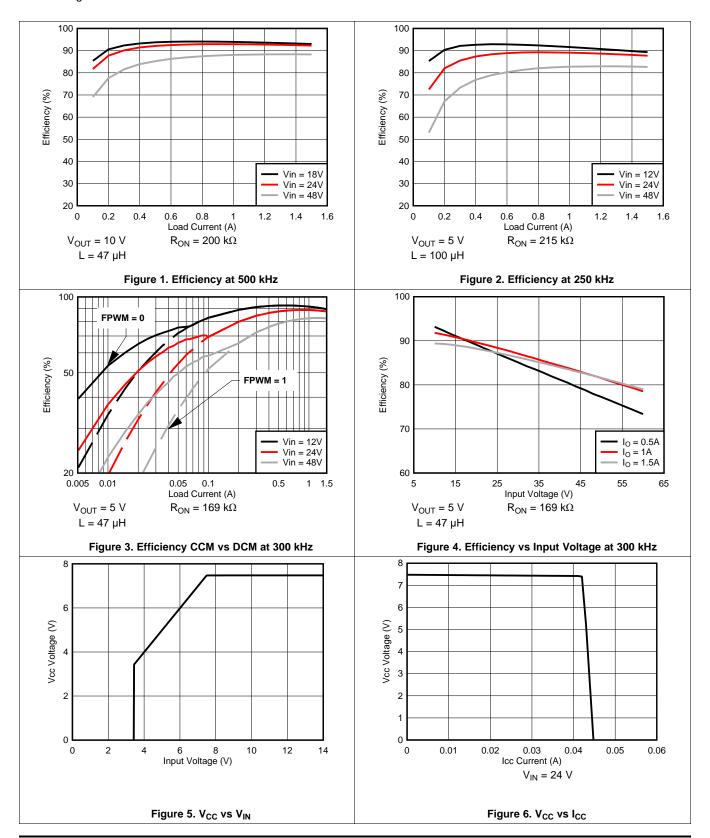
, IIN						
		MIN	TYP	MAX	UNIT	
MINIMUM OFF-TIME						
T <sub>OFF-MIN</sub>	Minimum off-time, $V_{FB} = 0 V$		170		ns	
ON-TIME G	ENERATOR					
T <sub>ON1</sub>	$V_{IN} = 24 \text{ V}, R_{ON} = 100 \text{ k}\Omega$	312	428	520	ns	
T <sub>ON2</sub>	$V_{IN} = 24 \text{ V}, R_{ON} = 200 \text{ k}\Omega$	625	818	1040	ns	
T <sub>ON3</sub>	$V_{IN}$ = 8 V, $R_{ON}$ = 100 k $\Omega$	937	1247	1563	ns	
T <sub>ON4</sub>	$V_{IN}$ = 65 V, $R_{ON}$ = 100 k $\Omega$	132	176	220	ns	

<sup>(1)</sup> All minimum and maximum limits are specified by correlating the electrical characteristics to process and temperature variations and applying statistical process control.



## 7.7 Typical Characteristics

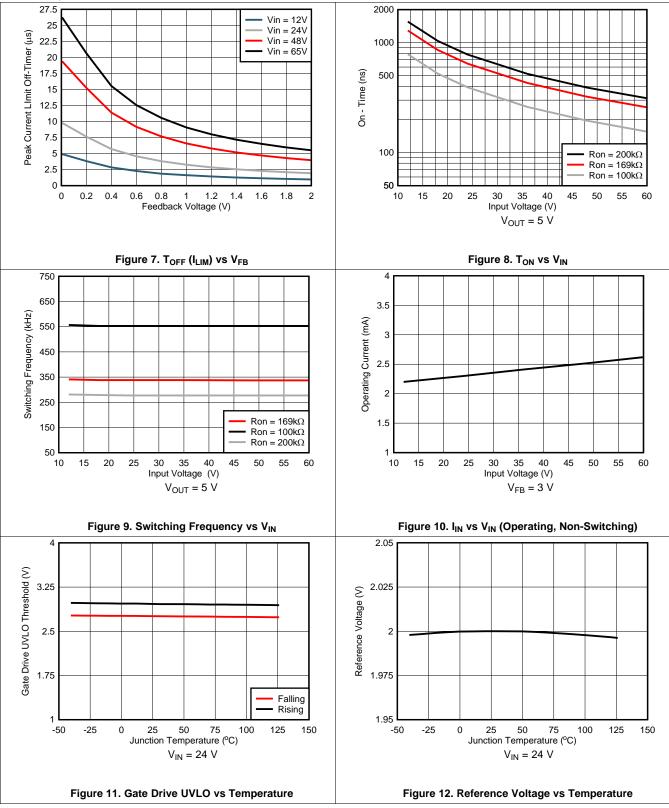
 $T_A = 25$ °C and applicable to both LM5160 and LM5160A, unless otherwise noted. Please refer to Typical Applications for circuit designs.





## **Typical Characteristics (continued)**

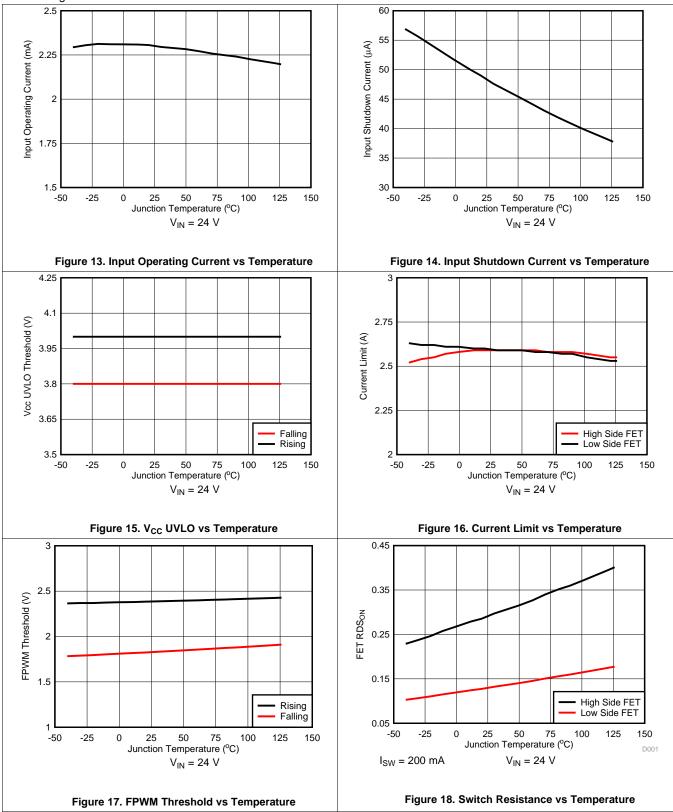
 $T_A = 25$ °C and applicable to both LM5160 and LM5160A, unless otherwise noted. Please refer to Typical Applications for circuit designs.





# **Typical Characteristics (continued)**

 $T_A = 25^{\circ}$ C and applicable to both LM5160 and LM5160A, unless otherwise noted. Please refer to Typical Applications for circuit designs.





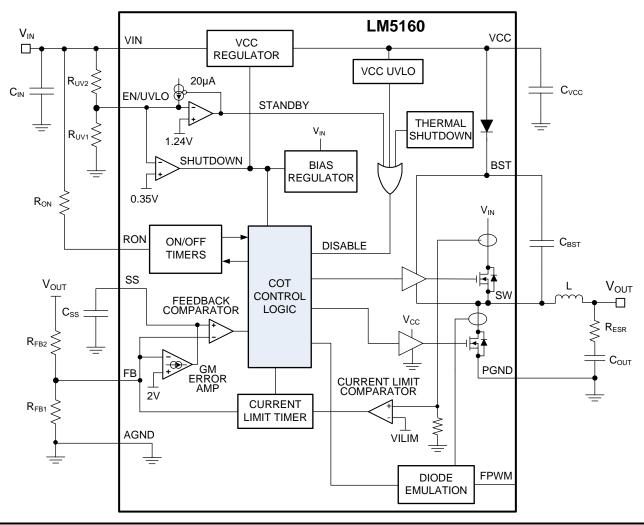
# 8 Detailed Description

#### 8.1 Overview

The LM5160/A step-down synchronous switching regulator features all the functions needed to implement a low-cost, efficient buck converter capable of supplying 2 A to the load. This high voltage regulator contains 65-V N-channel buck and synchronous rectifier switches and is available in a 12-pin WSON package with 0.5-mm pin pitch. The regulator operation is based on an adaptive constant on-time control architecture where the on-time is inversely proportional to input voltage  $V_{IN}$ . This feature maintains a relatively constant operating frequency with load and input voltage variations. A constant on-time switching regulator requires no loop compensation resulting in fast load transient response. Peak current limit detection circuit is implemented with a forced off-time during current limiting which is inversely proportional to voltage at the feedback pin,  $V_{FB}$  and directly proportional to  $V_{IN}$ . Varying the current limit off-time with  $V_{FB}$  and  $V_{IN}$  ensures short-circuit protection with minimal current limit foldback. The LM5160 can be applied in numerous end equipment systems requiring efficient step-down regulation from higher input voltages. This regulator is well-suited for 24-V industrial systems as well as 48-V telecom and PoE voltage ranges. The LM5160 integrates an undervoltage lockout (EN/UVLO) circuit to prevent faulty operation of the device at low input voltages and features intelligent current limit and thermal shutdown to protect the device during overload or short circuit.

The LM5160 device name is used generically throughout this document and represents both the LM5160 and LM5160A unless stated otherwise. The only difference between the two is the ability to connect an external voltage source to the VCC pin of the LM5160A.

## 8.2 Functional Block Diagram





## 8.3 Feature Description

#### 8.3.1 Control Circuit

The LM5160 step-down switching regulator employs a control principle based on a comparator and a one-shot timer, with the output voltage feedback (FB) compared to the voltage at the soft-start (SS) pin ( $V_{SS}$ ). If the FB voltage is below  $V_{SS}$ , the internal buck switch is turned on for a conduction time determined by the input voltage and the one-shot programming resistor ( $R_{ON}$ ). Following the on-time, the buck switch must stay off for the off-time forced by the minimum off-time one-shot. The buck switch remains off until the FB voltage falls below the SS voltage again, when it turns back on for another on-time interval.

During a rapid start-up or when the load current increases suddenly, the regulator operates with minimum offtime per cycle. When regulating the output in steady-state operation, the off-time automatically adjusts to produce the SW voltage duty cycle required for output voltage regulation.

When in regulation, the LM5160 operates in continuous conduction mode at heavy load currents. If FPWM is connected to ground or left floating, the regulator operates in discontinuous conduction mode at light load with the synchronous rectifier FET in diode emulation. With sufficient load, the LM5160 operates in continuous conduction mode with the inductor current never reaching zero during the off-time of the high-side FET. In this mode the operating frequency remains relatively constant with load and line variations. The minimum load current for continuous conduction mode is one-half the inductor's ripple current amplitude. The operating frequency is programmed by the resistor connected from VIN to RON and can be calculated from Equation 1 with  $R_{\rm ON}$  expressed in Ohms.

$$F_{sw} = \frac{V_{OUT}}{R_{ON} \times 1 \times 10^{-10}} \, Hz \tag{1}$$

In discontinuous conduction mode, current through the inductor ramps up from zero to a peak value during the on-time, then ramps back to zero before the end of the off-time. The next on-time interval starts when the voltage at FB falls below V<sub>SS</sub>. When the inductor current is zero during the high-side FET off-time, the load current is supplied by the output capacitor. In this mode, the operating switching frequency is lower than the continuous conduction mode switching frequency and the frequency varies with load. Discontinuous conduction mode maintains conversion efficiency at light loads because the switching losses reduce with the decrease in load and frequency.

The output voltage is set by two external resistors ( $R_{FB1}$ ,  $R_{FB2}$ ). Calculate the regulated output voltage from Equation 2.

$$V_{OUT} = \frac{V_{REF} \times (R_{FB2} + R_{FB1})}{R_{FB1}} V$$

where

## 8.3.2 VCC Regulator

The LM5160 contains an internal high-voltage linear regulator with a nominal output voltage of 7.5 V (typical). The VCC regulator is internally current limited to 30 mA (minimum). This regulator supplies power to internal circuit blocks including the synchronous FET gate driver and the logic circuits. When the VCC voltage reaches the undervoltage lockout (V<sub>CC(UV)</sub>) threshold of 3.98 V (typical), the IC is enabled. An external capacitor at the VCC pin stabilizes the regulator and supplies transient VCC current to the gate drivers. An internal diode connected from VCC to BST replenishes the charge in the high-side gate drive bootstrap capacitor when the SW voltage is low.

In high input voltage applications, the power dissipated in the regulator is significant and can limit the efficiency and maximum achievable output power. The LM5160A allows the internal VCC regulator power loss to be reduced by supplying the VCC voltage through a diode from an external voltage source regulated between 9 V and 13 V. The external VCC bias can be supplied from the LM5160A converter output rail if the regulation voltage is within this range. When the VCC pin of the LM5160A is raised above the regulation voltage (7.5 V typical), the internal regulator is disabled and the power dissipation in the IC is reduced. The only difference between the LM5160 and LM5160A is the wide operating  $V_{\rm CC}$  voltage range of the LM5160A.



## **Feature Description (continued)**

#### 8.3.3 Regulation Comparator

The feedback voltage at the FB pin is compared to the SS pin voltage  $V_{SS}$ . In normal operation when the output voltage is in regulation, an on-time interval is initiated when the voltage at FB pin falls below  $V_{SS}$ . The high-side buck switch stays on for a pre-defined on-time causing the FB voltage to rise. After the on-time interval expires, the high-side switch remains off until the FB voltage falls below  $V_{SS}$ . During start-up, the FB voltage is below  $V_{SS}$  at the end of each on-time interval and the high-side switch turns on again after the minimum forced off-time of 170 ns (typical). When the output is shorted to ground ( $V_{FB} = 0$  V), the high-side peak current limit is triggered, the high-side FET is turned off and remains off for a period determined by the current limit off-timer. See *Current Limit* for additional information.

#### 8.3.4 Soft Start

The soft-start feature of the LM5160 allows the converter to gradually reach a steady-state operating point, thereby reducing start-up stresses and current surges. When the EN/UVLO voltage is above the EN/UVLO standby threshold  $V_{UVLO(TH)} = 1.24 \text{ V}$  (typical) and the VCC voltage exceeds the VCC undervoltage threshold,  $V_{CC(UV)} = 3.98 \text{ V}$  (typical) , an internal 10- $\mu$ A current source charges the external capacitor at the SS pin ( $C_{SS}$ ) from 0 V to 2 V. The voltage at SS is the noninverting input of the internal FB comparator. The soft-start interval ends when the SS capacitor is charged to the 2-V reference level. The ramping voltage at SS produces a controlled, monotonic output voltage start-up. Use a minimum soft-start capacitance of 1 nF for all applications.

## 8.3.5 Error Amplifier

The LM5160 provides a transconductance  $(G_M)$  error amplifier that minimizes the difference between the reference voltage  $(V_{REF})$  and the average feedback (FB) voltage. This amplifier reduces the load and line regulation errors that are common in constant on-time regulators. The soft-start capacitor  $C_{SS}$  provides compensation for this error correction loop. The soft-start capacitor must be greater than 1 nF to ensure stability.

#### 8.3.6 On-Time Generator

The on-time of the LM5160 high-side MOSFET is determined by the  $R_{ON}$  resistor and is inversely proportional to the input voltage ( $V_{IN}$ ). The inverse relationship with  $V_{IN}$  results in a nearly constant frequency as  $V_{IN}$  is varied. Calculate the on-time from Equation 3 with  $R_{ON}$  expressed in Ohms.

$$T_{ON} = \frac{R_{ON} \times 1 \times 10^{-10}}{V_{IN}} s$$
 (3)

To set a specific continuous conduction mode switching frequency ( $F_{SW}$  expressed in Hz), determine the  $R_{ON}$  resistor from Equation 4.

$$R_{ON} = \frac{V_{OUT}}{F_{SW} \times 1 \times 10^{-10}} \Omega \tag{4}$$

 $R_{ON}$  must be selected for a minimum on-time (at maximum  $V_{IN}$ ) greater than 150 ns for proper operation. This minimum on-time requirement limits the maximum switching frequency of applications with relatively high  $V_{IN}$  and low  $V_{OUT}$ .

#### 8.3.7 Current Limit

The LM5160 provides an intelligent current limit off-timer that adjusts the off-time to reduce the foldback in the current limit. If the peak value of the current in the buck switch exceeds 2.5 A (typical), the present on-time interval is immediately terminated and a non-resettable off-timer is initiated. The length of the off-time is controlled by the FB voltage and the input voltage  $V_{IN}$ . As an example, when  $V_{FB} = 0$  V and  $V_{IN} = 24$  V, the off-time is set to 10  $\mu$ s. This condition occurs if the output is shorted or during the initial phase of start-up. In cases of output overload where the FB voltage is greater than zero volts (a soft short), the current limit off-time is reduced. Decreasing the off-time during less severe overloads reduces the current limit foldback, overload recovery time, and start-up time. Calculate the current limit off-time using Equation 5.

$$T_{OFF(CL)} = \frac{5V_{IN}}{24V_{FB} + 12} \,\mu s \tag{5}$$



## Feature Description (continued)

#### 8.3.8 N-Channel Buck Switch and Driver

The LM5160 integrates an N-channel buck switch and associated floating high-side gate driver. The gate driver circuit works in conjunction with an external bootstrap capacitor and an internal high voltage bootstrap diode. A 10-nF or larger ceramic capacitor connected between BST and SW provides the voltage to the high-side driver during the buck switch on-time. During the off-time, the SW node is pulled down to approximately 0 V and the bootstrap capacitor charges from VCC through the internal bootstrap diode. The minimum off-time of 170 ns (typical) provides a minimum time each cycle to recharge the bootstrap capacitor.

## 8.3.9 Synchronous Rectifier

The LM5160 provides an internal low-side synchronous rectifier N-channel FET. This low-side FET provides a low resistance path for the inductor current when the high-side FET is turned off.

With the FPWM pin connected to ground or left floating, the LM5160 synchronous rectifier operates in diode emulation mode. Diode emulation enables the pulse-skipping during light load conditions. This leads to a reduction in the average switching frequency at light loads. Switching losses and FET gate driver losses, both of which are proportional to switching frequency, are significantly reduced and efficiency is improved. This pulse-skipping mode also reduces the circulating inductor currents and losses associated with a continuous conduction mode (CCM).

When FPWM is pulled high, diode emulation is disabled. The inductor current can flow in either direction through the low-side FET, resulting in CCM operation with nearly constant switching frequency. A negative sink current limit circuit limits the current that can flow into SW and through the low-side FET to ground. In a buck regulator application, large negative current typically only flows from  $V_{OUT}$  to SW if  $V_{OUT}$  is lifted above the output regulation setpoint.

## 8.3.10 Enable / Undervoltage Lockout (EN/UVLO)

The LM5160 contains a dual-level undervoltage lockout (EN/UVLO) circuit. When the EN/UVLO voltage is below 0.35 V, the regulator is in a low-current shutdown mode. When the EN/UVLO voltage is greater than 0.35 V (typical) but less than 1.24 V (typical), the regulator is in standby mode. In standby mode, the VCC bias regulator is active but converter switching remains disabled. When the voltage at the VCC exceeds the VCC rising threshold,  $V_{CC(UV)} = 3.98 \text{ V}$  (typical), and the EN/UVLO voltage is greater than 1.24 V, normal switching operation begins. Use an external resistor voltage divider from VIN to GND to set the minimum operating voltage of the regulator.

EN/UVLO hysteresis is implemented with an internal 20  $\mu$ A (typical) current source (I<sub>UVLO(HYS)</sub>) that is switched on or off into the impedance of the EN/UVLO pin resistor divider. When the EN/UVLO threshold is exceeded, the current source is activated to effectively raise the voltage at the EN/UVLO pin. The hysteresis is equal to the value of this current times the upper resistance of the resistor divider, R<sub>UV2</sub>. See *Functional Block Diagram*.

## 8.3.11 Thermal Protection

The LM5160 must be operated such that the junction temperature does not exceed 150°C during normal operation. An internal thermal shutdown circuit is provided to protect the LM5160 in the event of higher than normal junction temperature. When activated, typically at 175°C, the controller is forced into a low-power reset state, disabling the high-side buck switch and the VCC regulator. This feature prevents catastrophic failures from accidental device overheating. When the junction temperature falls below 155°C (typical hysteresis of 20°C), the VCC regulator is enabled and operation resumes.



#### 8.4 Device Functional Modes

## 8.4.1 Forced Pulse Width Modulation (FPWM) Mode

The *Synchronous Rectifier* section gives a brief introduction to the LM5160 diode emulation feature. The FPWM pin allows the power supply designer to select either CCM or DCM operation at light loads. When FPWM is connected to ground or left floating (FPWM = 0), a pulse-skipping mode and a zero-cross current detector circuit are enabled. The zero-cross detector turns off the low-side FET when the inductor current falls to zero (I<sub>ZX</sub>, see *Electrical Characteristics*). This feature allows the LM5160 regulator to operate in DCM mode at light loads. In the DCM state, the switching frequency decreases with lighter loads.

If FPWM is pulled high (FPWM connected to VCC), the LM5160 operates in CCM even at light loads. This option allows the synchronous rectifier FET to conduct until the start of the next high-side switch cycle. The inductor current drops to zero and then reverse direction (negative direction through inductor), passing from drain to source of the low-side FET. The current flows continuously until the FB comparator initiates another high-side switch on-time. CCM operation reduces efficiency at light load but improves the transient response to step load changes and provides nearly constant switching frequency.

**Table 1. FPWM Pin Mode Summary** 

FPWM PIN CONNECTION	LOGIC STAGE	DESCRIPTION
GND or Floating (High Z)	0	The FPWM pin is grounded or left floating. DCM enabled at light loads.
V <sub>cc</sub>	1	The FPWM pin is connected to VCC. The LM5160 then operates in CCM mode at light loads.

## 8.4.2 Undervoltage Detector

The following table summarizes the dual threshold levels of the undervoltage lockout (EN/UVLO) circuit explained in *Enable / Undervoltage Lockout (EN/UVLO)*.

**Table 2. UVLO Pin Mode Summary** 

EN/UVLO PIN VOLTAGE	VCC REGULATOR	VCC REGULATOR MODE	
< 0.35 V	Off	Shutdown	V <sub>CC</sub> regulator disabled. High-side and low-side FETs disabled.
0.35 V to 1.24 V	On	Standby	V <sub>CC</sub> regulator enabled. High-side and low-side FETs disabled.
> 1.24 V	V <sub>CC</sub> < V <sub>CC(UV)</sub>	Standby	V <sub>CC</sub> regulator enabled. High-side and low-side FETs disabled.
	V <sub>CC</sub> > V <sub>CC(UV)</sub>	Operating	V <sub>CC</sub> regulator enabled. Switching enabled.

If input UVLO is not required, EN/UVLO can be driven by a logic signal as an enable input or connected directly to VIN. If EN/UVLO is directly connected to VIN, the regulator begins switching when  $V_{CC(UV)} = 3.98 \text{ V}$  (typical) is satisfied.



# 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 9.1 Application Information

The LM5160 is a synchronous buck or Fly-Buck DC/DC converter designed to operate over wide input voltage and output current ranges. LM5160 and LM5160A quick-start calculator tools are available for download to design a single-output synchronous buck converter or an isolated dual-output Fly-Buck converter. For a detailed design guide of the Fly-Buck converter, refer to *AN-2292 Designing an Isolated Buck (Fly-Buck) Converter* application report (SNVA674). Alternatively, use online WEBENCH software to create a complete buck or Fly-Buck design and generate the bill of materials, estimated efficiency, solution size and cost of the complete solution.

*Typical Applications* describes a few application circuits using the LM5160 or LM5160A with detailed, step-by-step design procedures.

## 9.1.1 Ripple Configuration

The LM5160 uses an adaptive constant on-time (COT) control scheme in which the PWM on-time is set by a one-shot timer and the off-time is set by the feedback voltage (V<sub>FB</sub>) falling below the reference voltage. Therefore, for stable operation, the feedback voltage must decrease monotonically in phase with the inductor current during the off-time. Furthermore, this change in feedback voltage (V<sub>FB</sub>) during the off-time must be large enough to dominate any noise present at the feedback node.

Table 3 presents three different methods for generating appropriate voltage ripple at the feedback node. Type 1 and Type 2 ripple circuits couple the ripple from the output of the converter to the feedback node (FB). The output voltage ripple has two components:

- 1. Capacitive ripple caused by the inductor ripple current charging or discharging the output capacitor.
- 2. Resistive ripple caused by the inductor ripple current flowing through the ESR of the output capacitor and R3.

**Table 3. Ripple Configurations** 

TYPE 1	TYPE 2	TYPE 3
Lowest Cost	Reduced Ripple	Minimum Ripple
V <sub>OUT</sub> R <sub>FB2</sub> R <sub>S</sub> R <sub>S</sub> C <sub>OUT</sub>	Vout  C <sub>II</sub> R <sub>FB2</sub> R <sub>S</sub> Cout  Cout  GND	Vout R <sub>A</sub> C <sub>A</sub> R <sub>FB2</sub> GND  R <sub>FB1</sub>
$R_3 \ge \frac{25 \text{ mV} \times V_O}{V_{REF} \times \Delta I_{L1, \text{min}}} $ (6)	$C_{ff} \ge \frac{5}{F_{SW} \times (R_{FB2} IIR_{FB1})}$ $R_3 \ge \frac{25 \text{ mV}}{\Delta I_{L1, \text{min}}}$ (7)	$R_A C_A \le \frac{(V_{IN, min} - V_O) \times T_{ON(@V_{IN, min})}}{25mV}$ (8)



The capacitive ripple is out-of-phase with the inductor current. As a result, the capacitive ripple does not decrease monotonically during the off-time. The resistive ripple is in phase with the inductor current and decreases monotonically during the off-time. The resistive ripple must exceed the capacitive ripple at output  $(V_{OUT})$  for stable operation. If this condition is not satisfied, unstable switching behavior is observed in COT converters with multiple on-time bursts in close succession followed by a long off-time.

Type 3 ripple method uses a ripple injection circuit with R<sub>A</sub>, C<sub>A</sub> and the switch-node (SW) voltage to generate a triangular ramp. This ramp is then AC-coupled into the feedback node (FB) using coupling capacitor C<sub>B</sub>. Because this circuit does not use the output voltage ripple, it is suited for applications where low output voltage ripple is imperative. For more information on each ripple generation method, refer to the *AN-1481 Controlling Output Ripple & Achiev ESR Indep Constant On-Time Regulator Designs* application note.

## 9.2 Typical Applications



For step-by-step design procedure, circuit schematics, bill of materials, PCB files, simulation and test results of an LM5160-powered implementation, refer to *Wide-Input Isolated IGBT Gate-Drive Fly-Buck Power Supply for Three-Phase Inverters* reference design.

## 9.2.1 LM5160 Synchronous Buck (10-V to 60-V Input, 5-V Output, 1.5-A Load)

A typical application example is a synchronous buck converter operating from a wide input voltage range of 10 V to 65 V and providing a stable 5-V output voltage with output current capability of 1.5 A. Figure 19 shows the complete schematic for a typical synchronous buck application circuit. The components are labeled by numbers instead of the descriptive name used in the previous sections. For example, R3 represents R<sub>ON</sub> and so forth.

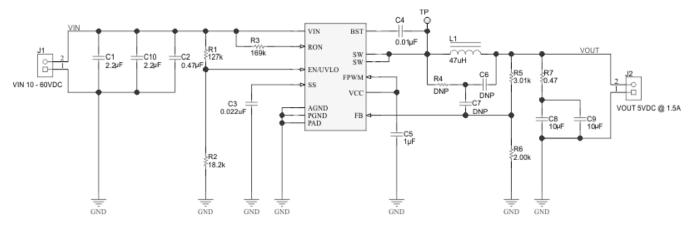


Figure 19. LM5160 Synchronous Buck Application Circuit

#### NOTE

This and subsequent design examples are provided herein to showcase the LM5160 converter in several different applications. Depending on the source impedance of the input supply bus, an electrolytic capacitor may be required at the input to ensure stability, particularly at low input voltage and high output current operating conditions. See *Power Supply Recommendations* for more detail.



#### 9.2.1.1 Design Requirements

Table 4 summarizes the operating parameters:

**Table 4. Design Parameters** 

DESIGN PARAMETER	EXAMPLE VALUE		
Input voltage range	10 V to 65 V		
Output	5 V		
Load current	1.5 A		
Nominal switching frequency	300 kHz		
Light-load operating mode	CCM, FPWM = VCC		

#### 9.2.1.2 Detailed Design Procedure

#### 9.2.1.2.1 Custom Design With WEBENCH® Tools

Click here to create a custom design using the LM5160A device with the WEBENCH® Power Designer.

- 1. Start by entering the input voltage  $(V_{IN})$ , output voltage  $(V_{OUT})$ , and output current  $(I_{OUT})$  requirements.
- 2. Optimize the design for key parameters such as efficiency, footprint, and cost using the optimizer dial.
- 3. Compare the generated design with other possible solutions from Texas Instruments.

The WEBENCH Power Designer provides a customized schematic along with a list of materials with real-time pricing and component availability.

In most cases, these actions are available:

- Run electrical simulations to see important waveforms and circuit performance
- Run thermal simulations to understand board thermal performance
- Export customized schematic and layout into popular CAD formats
- Print PDF reports for the design, and share the design with colleagues

Get more information about WEBENCH tools at www.ti.com/WEBENCH.

#### 9.2.1.2.2 Feedback Resistor Divider - R<sub>FB1</sub>, R<sub>FB2</sub>

With the required output voltage setpoint at 5 V and  $V_{FB} = 2 V$  (typical), calculate the ratio of R6 ( $R_{FB1}$ ) to R5 ( $R_{FB2}$ ) using Equation 9.

$$\frac{R_{FB2}}{R_{FB1}} = \frac{V_{OUT}}{V_{REF}} - 1 \tag{9}$$

The resistor ratio calculates to be 3:2. Choose standard values of R6 ( $R_{FB1}$ ) = 2 k $\Omega$  and R5 ( $R_{FB2}$ ) = 3.01 k $\Omega$ . Higher or lower values can be used as long as a ratio of the 3:2 is maintained.

## 9.2.1.2.3 Switching Frequency - Ron

The duty cycle required to maintain output regulation at the minimum input voltage restricts the maximum switching frequency of the LM5160. The maximum value of the minimum forced off-time, T<sub>OFF,min</sub>, limits the duty cycle and therefore the switching frequency. Calculate the maximum frequency that avoids output dropout at minimum input voltage using Equation 10.

$$F_{SW, max (@V_{IN, min})} = \frac{V_{IN, min} - V_{OUT}}{V_{IN, min} \times T_{OFF, min}(ns)}$$
(10)

For this design example, the maximum frequency based on the minimum off-time limitation of  $T_{OFF,min}$  (typical) = 170 ns is calculated as  $F_{SW,max(@VIN,min)}$  = 2.9 MHz. This value is well above 1 MHz, the maximum possible operating frequency of the LM5160.

At maximum input voltage the maximum switching frequency of the LM5160 is restricted by the minimum ontime, T<sub>ON,min</sub> which limits the minimum duty cycle of the converter. Calculate the maximum frequency at maximum input voltage using Equation 11.



$$F_{SW, \max(@V_{IN, \max})} = \frac{V_{OUT}}{V_{IN, \max} \times T_{ON, \min}(ns)}$$
(11)

Using Equation 11 and  $T_{ON,min}$  (typical) = 150 ns, the maximum achievable switching frequency is  $F_{SW,max(@VIN,min)}$  = 514 kHz. Taking this value as the maximum possible switching frequency over the input voltage range for this application, choose a nominal switching frequency of  $F_{SW}$  = 300 kHz for this design. The value of resistor  $R_{ON}$  sets the nominal switching frequency based on Equation 12.

$$R_{ON} = \frac{V_{OUT}}{F_{SW} \times 1 \times 10^{-10}} \Omega \tag{12}$$

For this particular application with  $F_{SW} = 300$  kHz,  $R_{ON}$  calculates to be 167 k $\Omega$ . Selecting a standard value for R3 ( $R_{ON}$ ) = 169 k $\Omega$  (±1%) results in a nominal frequency of 296 kHz. The resistor value may need to adjusted further in order to achieve the required switching frequency as the switching frequency in COT converters varies slightly (±10%) with input voltage and/or output current. Operation at a lower nominal switching frequency results in higher efficiency but increases the inductor and capacitor values leading to a larger total solution size.

#### 9.2.1.2.4 Inductor - L

Select the inductor to limit the inductor ripple current between 20 and 40 percent of the maximum load current. Calculate the minimum value of the inductance required in this application from Equation 13.

$$L_{min} = \frac{V_O \times (V_{IN, max} - V_O)}{V_{IN, max} \times F_{SW} \times I_{O, max} \times 0.4}$$
(13)

Based on Equation 13, determine the minimum value of the inductance as 26  $\mu$ H for  $V_{IN}$  = 65 V (maximum) and inductor ripple current equal to 40 percent of the maximum load current. Allowing some margin for inductance variation with current, select a higher standard value of L1 (L) = 47  $\mu$ H for this design.

The peak inductor current at maximum load must be smaller than the minimum current limit threshold of the highside FET, as given in *Electrical Characteristics* table. Determine the inductor ripple current at any input voltage using Equation 14.

$$\Delta I_{L} = \frac{V_{O} \times (V_{IN} - V_{O})}{V_{IN} \times F_{SW} \times L}$$
(14)

Calculate the peak-to-peak inductor ripple current as 180 mA and 332 mA at the minimum and maximum input voltages, respectively. Determine the maximum peak inductor current in the buck FET using Equation 15.

$$I_{L(peak)} = I_{O, max} + \frac{\Delta I_{L, max}}{2}$$
(15)

In this design with an output current of 1.5 A, the maximum peak inductor current is calculated to be approximately 1.67 A, which is less than the high-side FET minimum current limit threshold.

The saturation current of the inductor must also be carefully considered. The peak value of the inductor current is bound by the high-side FET current limit during overload or short circuit conditions. Based on the high-side FET current limit specification in *Electrical Characteristics*, select an inductor with saturation current rating above 2.875 A.

## 9.2.1.2.5 Output Capacitor - Cout

Select the output capacitor to limit the capacitive ripple at the output of the regulator. Maximum capacitive ripple is observed at maximum input voltage. The output capacitance required for a ripple voltage  $\Delta V_O$  across the capacitor is given by Equation 16.

$$C_{OUT} = \frac{\Delta I_{L, max}}{8 \times F_{SW} \times \Delta V_{O, ripple}}$$
(16)

Substituting  $\Delta V_{O, ripple} = 10$  mV gives  $C_{OUT} = 14$   $\mu F$ . Two standard 10- $\mu F$  ceramic capacitors in parallel (C8, C9) are selected. An X7R type capacitor with a voltage rating 16 V or higher must be used for  $C_{OUT}$  (C8, C9) to limit the reduction of capacitance due to DC bias voltage.



#### 9.2.1.2.6 Series Ripple Resistor - R<sub>ESR</sub>

Select the series resistor such that sufficient ripple is injected at the feedback node (FB). The ripple voltage produced by  $R_{ESR}$  is proportional to the inductor ripple current. Therefore, select  $R_{ESR}$  based on the lowest inductor ripple current occurring at minimum input voltage. Calculate  $R_{ESR}$  using Equation 17.

$$R_{ESR} \ge \frac{25 \text{ mV} \times V_{O}}{V_{REF} \times \Delta I_{L, min}}$$
(17)

With  $V_O = 5$  V,  $V_{REF} = 2$  V and  $\Delta I_{L, min} = 180$  mA (at  $V_{IN, min} = 10$  V) as calculated in Equation 14, Equation 17 requires an  $R_{ESR}$  greater than or equal to 0.35  $\Omega$ . Selecting R7 ( $R_{ESR}$ ) = 0.47  $\Omega$  results in approximately 150 mV of maximum output voltage ripple at  $V_{IN, max}$ . For applications requiring lower output voltage ripple, use Type II or Type III ripple injection circuits as described in *Ripple Configuration*.

## 9.2.1.2.7 VCC and Bootstrap Capacitors - C<sub>VCC</sub>, C<sub>BST</sub>

The VCC capacitor charges the bootstrap capacitor during the off-time of the high-side switch and powers internal logic circuits and the low-side sync FET gate driver. The bootstrap capacitor biases the high-side gate driver during the high-side FET on-time. Recommended values for C5 ( $C_{VCC}$ ) and C4 ( $C_{BST}$ ) are 1  $\mu$ F and 10 nF, respectively. Both must be high-quality X7R ceramic capacitors.

## 9.2.1.2.8 Input Capacitor - CIN

The input capacitor must be large enough to limit the input voltage ripple to an acceptable level. Equation 18 provides the input capacitance  $C_{IN}$  required for a worst-case input ripple of  $\Delta V_{IN, ripple}$ .

$$C_{IN} = \frac{I_{O, \text{max}} \times D \times (1 - D)}{\Delta V_{IN, \text{ripple}} \times F_{SW}}$$
(18)

 $C_{IN}$  (C1, C10) supplies most of the switch current during the on-time to limit the voltage ripple at the VIN pin. At maximum load current, when the buck switch turns on, the current into the VIN pin quickly increases to the valley current of the inductor ripple and then ramps up to the peak of the inductor ripple during the on-time of the high-side FET. The average current during the on-time is the output load current. For a worst-case calculation,  $C_{IN}$  must supply this average load current during the maximum on-time, without letting the voltage at VIN drop more than the desired input ripple. For this design, the input voltage drop is limited to 0.5 V and the value of  $C_{IN}$  is calculated using Equation 18.

Based on Equation 18, the value of the input capacitor is determined as approximately 2.5  $\mu$ F at D = 0.5. Taking into account the decrease in capacitance with applied voltage, two standard value 2.2- $\mu$ F, 100-V, X7R ceramic capacitors are selected for C1 and C10. The input capacitors must be rated for the maximum input voltage under all operating and transient conditions.

A third input capacitor C2 may be needed in this design as a bypass path for the high-frequency components of input switching current. The value of C2 is 0.47  $\mu$ F and this bypass capacitor must be placed directly across VIN and PGND (pins 3 and 2) near the IC. The C<sub>IN</sub> values and location are critical to reducing switching noise and transients.

#### 9.2.1.2.9 Soft-Start Capacitor - C<sub>SS</sub>

The capacitor at the SS pin determines the soft-start time, that is, the time for the output voltage to reach its final steady-state value. Determine the SS capacitor value from Equation 19:

$$C_{SS} = \frac{I_{SS} \times T_{Startup}}{V_{SS}}$$
 (19)

With C3 (C<sub>SS</sub>) set at 22 nF and  $V_{SS} = 2 \text{ V}$ ,  $I_{SS} = 10 \mu\text{A}$ ,  $T_{Startup}$  is approximately 4 ms.

#### 9.2.1.2.10 EN/UVLO Resistors - R<sub>UV1</sub>, R<sub>UV2</sub>

The UVLO resistors R1 ( $R_{UV2}$ ) and R2 ( $R_{UV1}$ ) set the input undervoltage lockout threshold and hysteresis according to Equation 20 and Equation 21.

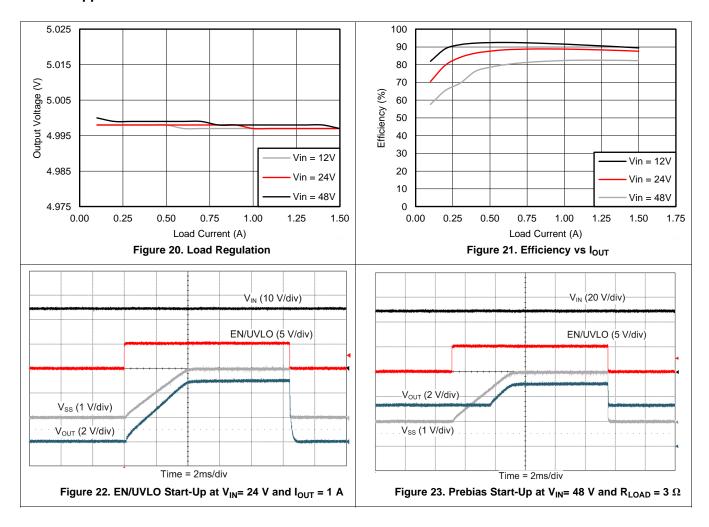
$$V_{IN(HYS)} = I_{UVLO(HYS)} \times R_{UV2}$$
(20)



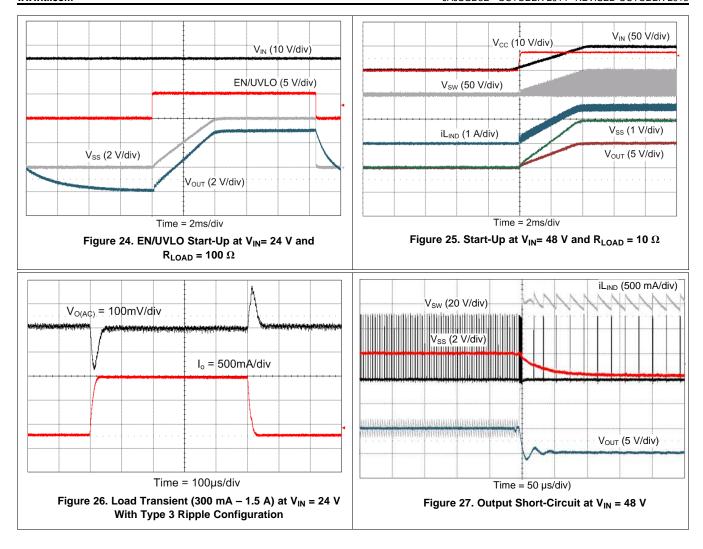
$$V_{IN,UVLO(rising)} = V_{UVLO(TH)} \left( 1 + \frac{R_{UV2}}{R_{UV1}} \right)$$
(21)

From the *Electrical Characteristics* table,  $I_{UVLO(HYS)}=20~\mu A$  (typical). To design for a  $V_{IN}$  rising threshold ( $V_{IN}$ , UVLO(rising)) of 10 V and hysteresis of 2.5 V, Equation 20 and Equation 21 yield  $R_{UV1}=17.98~k\Omega$  and  $R_{UV2}=125~k\Omega$ . Selecting 1% standard values of R2 ( $R_{UV1}$ ) = 18.2  $k\Omega$  and R1 ( $R_{UV2}$ ) = 127  $k\Omega$  result in UVLO rising threshold and hysteresis voltages of 9.89 V and 2.54 V, respectively.

## 9.2.1.3 Application Curves









## 9.2.2 LM5160 Isolated Fly-Buck (18-V to 32-V Input, 12-V, 4.5-W Isolated Output)



For technical solutions, industry trends, and insights for designing and managing power supplies, please refer to Tl's Power House blog series.

Below is an application example of an isolated Fly-Buck converter that operates over an input voltage range of 18 V to 32 V. It provides a stable 12-V isolated output voltage with an output power capability of 4.5 W. Figure 28 shows the complete schematic of the Fly-Buck application circuit.

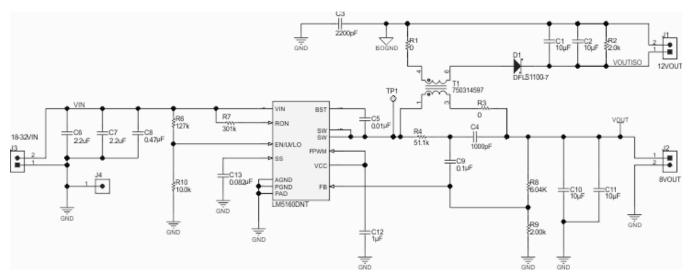


Figure 28. LM5160 12-V, 4.5-W Fly-Buck Converter Schematic

#### 9.2.2.1 LM5160 Fly-Buck Design Requirements

This LM5160 Fly-Buck application example is designed to operate from a 24-V DC supply with line variations from 18 V to 32 V. The example provides a space-optimized and efficient 12-V isolated output solution with secondary load current capability from 0 mA to 400 mA. The primary side remains unloaded in this application. The switching frequency is set at 300 kHz (nominal). This design achieves greater than 88% peak efficiency.

DESIGN PARAMETER	EXAMPLE VALUE		
Input voltage range	18 V to 32 V		
Isolated output	12 V		
Isolated load current range	0 mA to 400 mA		
Nominal switching frequency	300 kHz		
Peak Efficiency	88%		

**Table 5. Design Parameters** 

## 9.2.2.2 Detailed Design Procedure

The Fly-Buck converter design procedure closely follows the buck converter design outlined in *LM5160* Synchronous Buck (10-V to 60-V Input, 5-V Output, 1.5-A Load). The selection of primary output voltage, transformer turns ratio, rectifier diode, and output capacitors are covered here.

## 9.2.2.2.1 Selection of V<sub>OUT1</sub> and Turns Ratio

The primary-side output voltage of a Fly-Buck converter must be no more than one half of the minimum input voltage. For a minimum  $V_{IN}$  of 18 V, the primary output voltage ( $V_{OUT}$ ) must be no higher than 9 V. To generate an isolated output voltage of  $V_{OUT(ISO)} = 12$  V, a transformer turns ratio of 1 : 1.5 (N1 : N2) is selected. Using this turns ratio, calculate the required primary output voltage  $V_{OUT}$  using Equation 22.



$$V_{OUT} = \frac{V_{OUT(ISO)} + 0.7 \text{ V}}{1.5} = 8.47 \text{ V}$$
(22)

The 0.7 V subtracted from  $V_{OUT(ISO)}$  represents the forward voltage drop of the secondary rectifier diode. Fine tuning the primary side  $V_{OUT1}$  may be required to account for voltage errors due to the leakage inductance of the transformer and the resistance of the transformer windings and the low-side MOSFET of the LM5160.

#### 9.2.2.2.2 Secondary Rectifier Diode

The secondary rectifier diode must block the maximum input voltage multiplied by the transformer turns ratio. Determine the minimum diode reverse voltage  $V_{R(diode)}$  rating from Equation 23.

$$V_{R(diode)} = V_{IN(max)} \times \frac{N2}{N1} + V_{OUT(ISO)} = 32 \text{ V} \times 1.5 + 12 \text{ V} = 60 \text{ V}$$
(23)

Select a diode with 60 V or higher reverse voltage rating for this application. If the input voltage (V<sub>IN</sub>) has transients above the normal operating maximum input voltage of 32 V, then the worst-case transient input voltage must be used in the diode voltage calculation given by Equation 23.

## 9.2.2.2.3 External Ripple Circuit

A Type 3 ripple circuit is required for Fly-Buck converter applications. The design procedure for ripple components is identical to that in a buck converter. See *Ripple Configuration* for ripple design information.

## 9.2.2.2.4 Output Capacitor - Cout2

The Fly-Buck output capacitor conducts higher ripple current than a buck converter output capacitor. Calculate the capacitive ripple for the isolated output capacitor based on the time the rectifier diode is off. During this time the entire output current is supplied by the output capacitor. Calculate the required capacitance for a worst-case  $V_{OUT}(V_{OUT}(ISO))$  ripple voltage using Equation 24.

$$C_{OUT2} = \frac{I_{OUT2}}{\Delta V_{OUT2}} \Biggl( \frac{V_{OUT1}}{V_{IN(MIN)}} \Biggr) \times \frac{1}{f_{sw}}$$

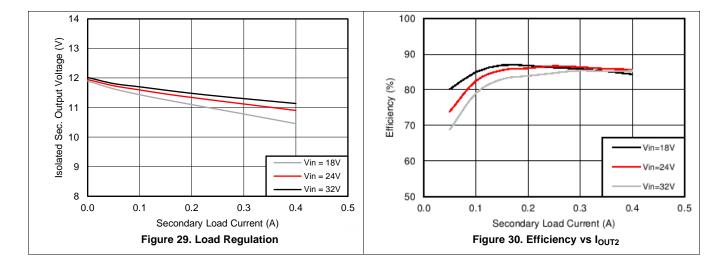
where

•  $\Delta V_{OUT2}$  is the target ripple at the secondary output.

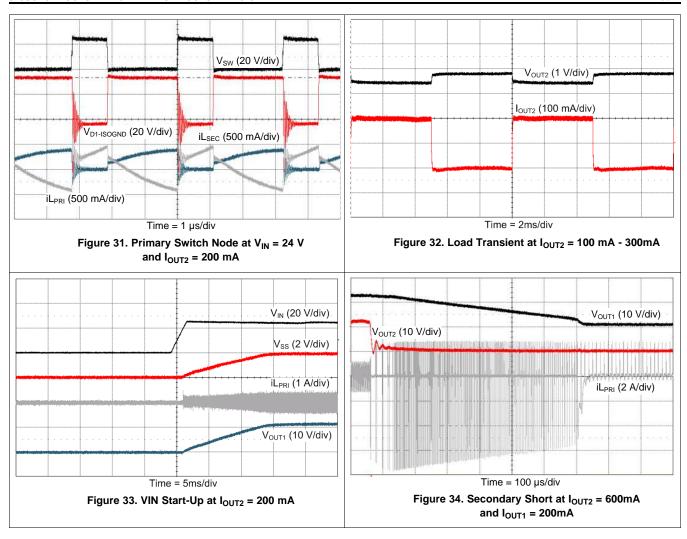
(24)

Equation 24 is an approximation and ignores the ripple components associated with ESR and ESL of the output capacitor. For a  $\Delta V_{OUT2} = 100$  mV, Equation 24 requires  $C_{OUT2} = 6.5$   $\mu F$ . When selecting a ceramic capacitor, consider its voltage coefficient to ensure sufficient capacitance at the output voltage operating point.

#### 9.2.2.3 Application Curves









#### 9.2.3 LM5160A Isolated Fly-Buck (18-V to 32-V Input, 12-V, 4.5-W Isolated Output)

The LM5160A when used in either the buck or the Fly-Buck application, can also be biased by an external voltage source for improved efficiency requirements. The LM5160A can be externally biased to VOUT by connecting VCC to VOUT through a diode as shown in the Fly-Buck application circuit in Figure 35. In this dual output rail Fly-Buck application circuit, the VCC pin is externally diode connected (D2) to VOUT (primary). The design procedure with the LM5160A, for both Buck and Fly-Buck configurations, remains the same as with LM5160. The voltage applied to the VCC pin, either from VOUT or an external supply must be between 9 V and 13 V.

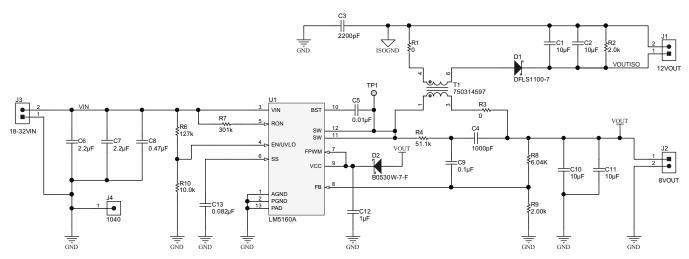


Figure 35. LM5160A 12-V, 4.5-W Fly-Buck Isolated Converter Schematic

## 9.3 Do's and Don'ts

As mentioned earlier in *Soft Start*, the SS capacitor  $C_{SS}$  must always be more than 1 nF in both buck and Fly-Buck converter applications. Apart from determining the start-up time, this capacitor serves as the external compensation of the internal  $G_M$  error amplifier. A minimum value of 1 nF is necessary to maintain stability. The SS pin must not be left floating.

The VCC pin of the LM5160 must not be biased with an external voltage source. When an improved efficiency requirement warrants an external  $V_{CC}$  bias, the LM5160A must be used.



## 10 Power Supply Recommendations

The LM5160 DC/DC converter is designed to operate from a wide input voltage range of 4.5 V to 65 V. The characteristics of the input supply must be compatible with the *Absolute Maximum Ratings* and *Recommended Operating Conditions* tables. In addition, the input supply must be capable of delivering the required input current to the fully-loaded regulator. Estimate the average input current with Equation 25.

$$I_{IN} = \frac{P_{OUT}}{V_{IN} \cdot \eta}$$

where

 $\eta$  is the efficiency (25)

If the regulator is connected to an input supply through long wires or PCB traces with a large impedance, take special care to achieve stable performance. The parasitic inductance and resistance of the input cables may have an adverse affect on converter operation, particularly during operation at low input voltage. The parasitic inductance in combination with the low-ESR ceramic input capacitors form an underdamped resonant circuit. This circuit can cause overvoltage transients at VIN each time the input supply is cycled on and off. The parasitic resistance causes the input voltage to dip during a load transient. The best way to solve such issues is to reduce the distance from the input supply to the regulator and use an aluminum or tantalum input capacitor in parallel with the ceramics. The moderate ESR of the electrolytic capacitors helps to damp the input resonant circuit and reduce any voltage overshoots. A capacitance in the range of 10  $\mu$ F to 47  $\mu$ F is usually sufficient to provide input parallel damping and helps to hold the input voltage steady during large load transients.

An EMI input filter is often used in front of the regulator that, unless carefully designed, can lead to instability as well as some of the effects mentioned above. The application report Simple Success with Conducted EMI for DC-DC Converters (SNVA489) provides helpful suggestions when designing an input filter for any switching regulator.



## 11 Layout

## 11.1 Layout Guidelines

A proper layout is essential for optimum performance of the circuit. In particular, observe the following guidelines:

- C<sub>IN</sub>: The loop consisting of input capacitor (C<sub>IN</sub>), VIN pin and PGND pin carries the switching current. The
  input capacitor must be placed close to the IC, directly across VIN and PGND pins, and the connections to
  these two pins must be direct to minimize the switching power loop area. In general, it is not possible to place
  all of input capacitances near the IC. A good layout practice includes placing the bulk capacitor(s) as close as
  possible to the VIN pin (see Figure 36).
- C<sub>VCC</sub> and C<sub>BST</sub>: The VCC and bootstrap (BST) bypass capacitors supply switching currents to the high-side
  and low-side gate drivers. These two capacitors must also be placed as close to the IC as possible, and the
  connecting trace length and loop area must be minimized (see Figure 36).
- The feedback trace carries the output voltage information and a small ripple component that is necessary for
  proper operation of the LM5160/A. Therefore, take care while routing the feedback trace to avoid coupling
  any noise into this pin. In particular, the feedback trace must be short and not run close to magnetic
  components, or parallel to any other switching trace.
- SW trace: The SW node switches rapidly between VIN and GND every cycle and is therefore a source of noise. The SW node copper area must be minimized. In particular, the SW node must not be inadvertently connected to a copper plane or pour.

## 11.2 Layout Example

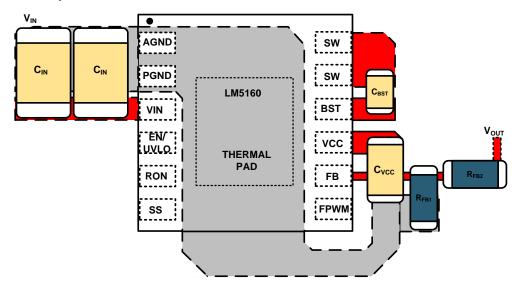


Figure 36. Placement of Bypass Capacitors



# 12 デバイスおよびドキュメントのサポート

## 12.1 デバイス・サポート

#### 12.1.1 デベロッパー・ネットワークの製品に関する免責事項

デベロッパー・ネットワークの製品またはサービスに関するTIの出版物は、単独またはTIの製品、サービスと一緒に提供される場合に関係なく、デベロッパー・ネットワークの製品またはサービスの適合性に関する是認、デベロッパー・ネットワークの製品またはサービスの是認の表明を意味するものではありません。

#### 12.1.2 開発サポート

開発サポートについては、以下を参照してください。

- LM5160降圧レギュレータ、クイック・スタート・カリキュレータ
- LM5160降圧レギュレータ、クイック・スタート・カリキュレータ
- LM5160 PSpiceトランジェント・モデル
- LM5160 非暗号化PSpiceトランジェント・モデル
- LM5160 TINA-TIフライバック・リファレンス・デザイン
- TIのリファレンス・デザイン・ライブラリについては、TIDesignsを参照してください。
- TIのWEBENCH設計環境については、WEBENCH<sup>®</sup>設計センターを参照してください。
- この製品の関連デバイスを参照するには、LM5161 100V、1A同期整流降圧コンバータ』を参照してください。

#### 12.1.2.1 WEBENCH®ツールによるカスタム設計

ここをクリックすると、WEBENCH® Power Designerにより、LM5160Aデバイスを使用するカスタム設計を作成できます。

- 1. 最初に、入力電圧( $V_{IN}$ )、出力電圧( $V_{OUT}$ )、出力電流( $I_{OUT}$ )の要件を入力します。
- 2. オプティマイザのダイヤルを使用して、効率、占有面積、コストなどの主要なパラメータについて設計を最適化します。
- 3. 生成された設計を、テキサス・インスツルメンツが提供する他の方式と比較します。

WEBENCH Power Designerでは、カスタマイズされた回路図と部品リストを、リアルタイムの価格と部品の在庫情報と併せて参照できます。

通常、次の操作を実行可能です。

- 電気的なシミュレーションを実行し、重要な波形と回路の性能を確認する。
- 熱シミュレーションを実行し、基板の熱特性を把握する。
- カスタマイズされた回路図やレイアウトを、一般的なCADフォーマットで出力する。
- 設計のレポートをPDFで印刷し、設計を共有する。

WEBENCHツールの詳細は、www.ti.com/WEBENCHでご覧になれます。

## 12.2 ドキュメントのサポート

#### 12.2.1 関連資料

関連資料については、以下を参照してください。

- 『LM5160A、LM5160 降圧EVMユーザー・ガイド』(SNVU441)
- 『LM5160 Fly-Buck(絶縁型降圧)ユーザー・ガイド』(SNVU408)
- 『AN-2292 絶縁型降圧(Fly-Buck)コンバータの設計』(SNVA674)
- 『AN-1481 コンスタント・オンタイム方式のレギュレータ設計における出力リップルの制御とESRの独立性確保』 (SNVA166)
- TI Designs:
  - 『気中遮断器(ACB)用の高分解能、高速スタートアップのデルタ-シグマADCベースAFEのリファレンス・デザイン』 (TIDUB80)
  - 『広入力、絶縁型IGBTゲート駆動Fly-Buck電源、三相インバータ用』(TIDU670)
  - 『25W PLCコントローラ・ユニット用の入力保護およびバックアップ電源のリファレンス・デザイン』(TIDUCC7)
  - 『24VAC 電源を使用する、非絶縁型 RS-485 から Wi-Fi へのブリッジのリファレンス・デザイン』(TIDUA48)
  - 『24VAC 電源を使用する、絶縁型 RS-485 から Wi-Fi へのブリッジのリファレンス・デザイン』(TIDUA49)



## ドキュメントのサポート (continued)

- 『超小型結合インダクタを使用するデュアル出力絶縁型Fly-Buckのリファレンス・デザイン』(TIDUC31)
- 『2.5Wバイポーラ絶縁型Fly-Buck超小型のリファレンス・デザイン』(TIDUCA3)
- 『アナログ入力モジュール向けの小型絶縁型DC/DCコンバータのリファレンス・デザイン』(TIDUBR7)
- 『超音波用の2.3nV√Hz、差動、時間ゲイン制御(TGC) DACのリファレンス・デザイン』(TIDUD38)
- 『絶縁抵抗判定用のリーク電流測定のためのリファレンス・デザイン』(TIDU873)
- 『PoEアプリケーション用Class 3絶縁Fly-Buck電源モジュールのリファレンス・デザイン』(TIDU779)
- 『HEV/EV のトラクション用インバータ向け IGBT モジュール過熱保護のリファレンス・デザイン』(TIDUBJ2)
- ホワイト・ペーパー
  - 『Fly-Buckコンバータを使用した絶縁型レールの迅速な設計』
  - 『コスト効率の優れた、要求の厳しいアプリケーション用の広V<sub>IN</sub>、低EMIの同期整流降圧回路の評価』
  - 『電源の伝導EMI仕様の概要』
  - 『電源の放射EMI仕様の概要』
- Power Houseプログ
  - 「Fly-Buck:よくある質問(FAQ)」
  - 「Lower EMI and quiet switching with the Fly-Buck™ topology」
  - Fly-Buck converter PCB layout tips.
  - When is Fly-Buck the right choice for your isolated power needs?
  - 「How to design for EMC and isolation with Fly-Buck™ converters」
  - Create a Fly-Buck<sup>™</sup> converter in WEBENCH® Power Designer
- 『AN-2162: DC/DCコンバータから伝導されるEMIでの簡単な成功』(SNVA489)
- 『新しい熱測定基準の使用』(SBVA025)
- 『半導体とICパッケージの熱指標』(SPRA953)

## 12.3 関連リンク

次の表に、クイック・アクセス・リンクを示します。カテゴリには、技術資料、サポートおよびコミュニティ・リソース、ツールとソフトウェア、およびサンプル注文またはご購入へのクイック・アクセスが含まれます。

## 表 6. 関連リンク

製品	プロダクト・フォルダ	サンプルとご購入	技術資料	ツールとソフトウェア	サポートとコミュニティ
LM5160	ここをクリック	ここをクリック	ここをクリック	ここをクリック	ここをクリック
LM5160A	ここをクリック	ここをクリック	ここをクリック	ここをクリック	ここをクリック

## 12.4 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、ti.comのデバイス製品フォルダを開いてください。右上の隅にある「通知を受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

## 12.5 コミュニティ・リソース

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™オンライン・コミュニティ *TIのE2E(Engineer-to-Engineer)コミュニティ。*エンジニア間の共同作業を促進するために開設されたものです。e2e.ti.comでは、他のエンジニアに質問し、知識を共有し、アイディアを検討して、問題解決に役立てることができます。

設計サポート *TIの設計サポート* 役に立つE2Eフォーラムや、設計サポート・ツールをすばやく見つけることができます。技術サポート用の連絡先情報も参照できます。

## 12.6 商標

Fly-Buck, E2E are trademarks of Texas Instruments.



## 12.6 商標 (continued)

WEBENCH is a registered trademark of Texas Instruments. All other trademarks are the property of their respective owners.

## 静電気放電に関する注意事項



すべての集積回路は、適切なESD保護方法を用いて、取扱いと保存を行うようにして下さい。

静電気放電はわずかな性能の低下から完全なデバイスの故障に至るまで、様々な損傷を与えます。高精度の集積回路は、損傷に対して敏感であり、極めてわずかなパラメータの変化により、デバイスに規定された仕様に適合しなくなる場合があります。

## 12.8 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 メカニカル、パッケージ、および注文情報

以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。これらの情報は、指定のデバ イスに対して提供されている最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合 もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。

www.ti.com 10-Nov-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking
	( )	( )			(-/	(4)	(5)		(-)
LM5160ADNTJ	Active	Production	WSON (DNT)   12	4500   JUMBO T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTJ.A	Active	Production	WSON (DNT)   12	4500   JUMBO T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTJ.B	Active	Production	WSON (DNT)   12	4500   JUMBO T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTR	Active	Production	WSON (DNT)   12	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTR.A	Active	Production	WSON (DNT)   12	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTR.B	Active	Production	WSON (DNT)   12	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTT	Active	Production	WSON (DNT)   12	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTT.A	Active	Production	WSON (DNT)   12	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160ADNTT.B	Active	Production	WSON (DNT)   12	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160A
LM5160DNTJ	Active	Production	WSON (DNT)   12	4500   JUMBO T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160
LM5160DNTJ.A	Active	Production	WSON (DNT)   12	4500   JUMBO T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160
LM5160DNTR	Active	Production	WSON (DNT)   12	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160
LM5160DNTR.A	Active	Production	WSON (DNT)   12	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160
LM5160DNTT	Active	Production	WSON (DNT)   12	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160
LM5160DNTT.A	Active	Production	WSON (DNT)   12	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM5160

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE OPTION ADDENDUM**

www.ti.com 10-Nov-2025

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF LM5160:

Automotive : LM5160-Q1

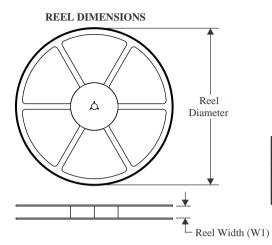
NOTE: Qualified Version Definitions:

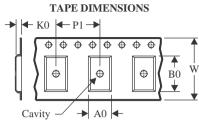
Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 31-Jul-2025

## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

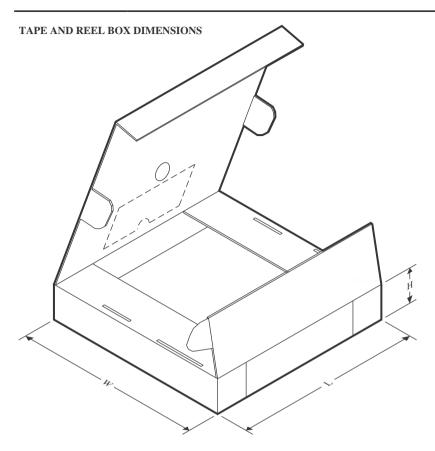


#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM5160ADNTJ	WSON	DNT	12	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LM5160ADNTR	WSON	DNT	12	1000	177.8	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LM5160ADNTT	WSON	DNT	12	250	177.8	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LM5160DNTJ	WSON	DNT	12	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LM5160DNTR	WSON	DNT	12	1000	177.8	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LM5160DNTT	WSON	DNT	12	250	177.8	12.4	4.3	4.3	1.3	8.0	12.0	Q1



www.ti.com 31-Jul-2025

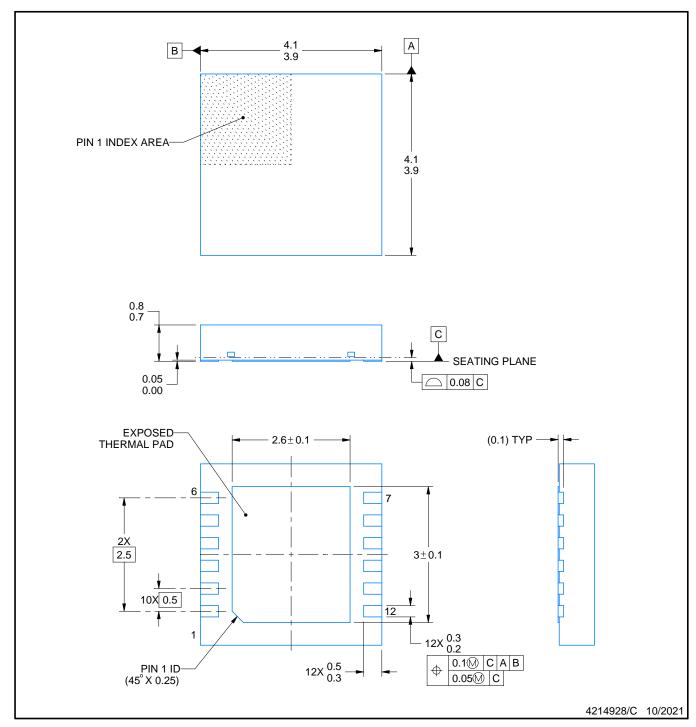


## \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM5160ADNTJ	WSON	DNT	12	4500	367.0	367.0	35.0
LM5160ADNTR	WSON	DNT	12	1000	208.0	191.0	35.0
LM5160ADNTT	WSON	DNT	12	250	208.0	191.0	35.0
LM5160DNTJ	WSON	DNT	12	4500	367.0	367.0	35.0
LM5160DNTR	WSON	DNT	12	1000	208.0	191.0	35.0
LM5160DNTT	WSON	DNT	12	250	208.0	191.0	35.0



PLASTIC SMALL OUTLINE - NO LEAD



## NOTES:

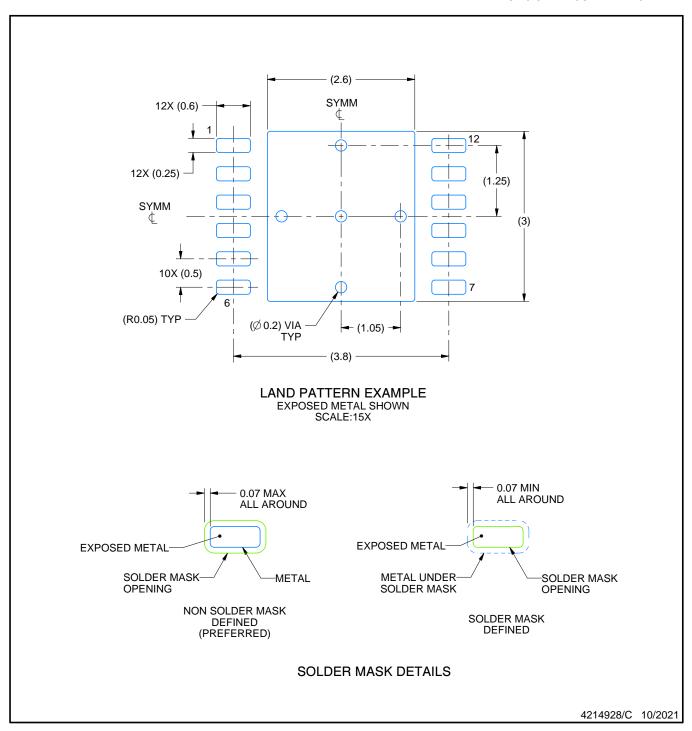
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC SMALL OUTLINE - NO LEAD

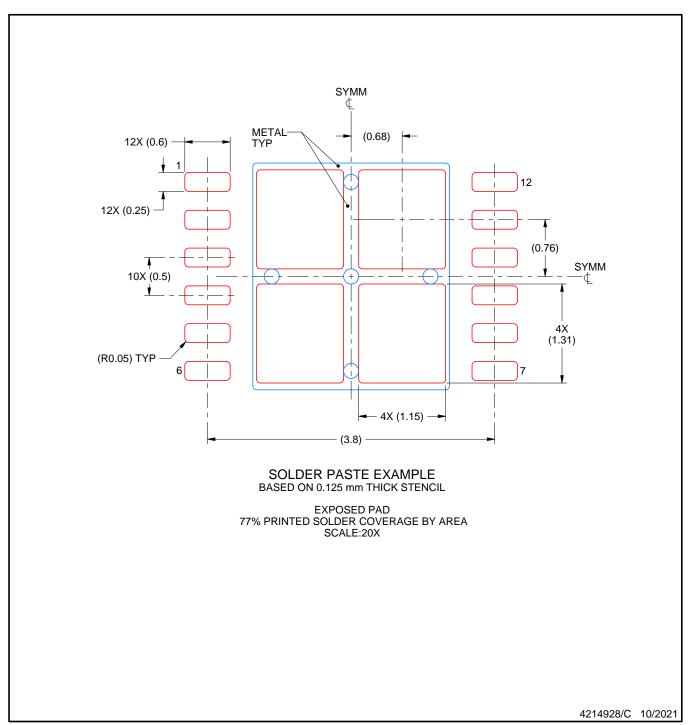


NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).



PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



## 重要なお知らせと免責事項

TI は、技術データと信頼性データ (データシートを含みます)、設計リソース (リファレンス デザインを含みます)、アプリケーションや設計に関する各種アドバイス、Web ツール、安全性情報、その他のリソースを、欠陥が存在する可能性のある「現状のまま」提供しており、商品性および特定目的に対する適合性の黙示保証、第三者の知的財産権の非侵害保証を含むいかなる保証も、明示的または黙示的にかかわらず拒否します。

これらのリソースは、TI 製品を使用する設計の経験を積んだ開発者への提供を意図したものです。(1) お客様のアプリケーションに適した TI 製品の選定、(2) お客様のアプリケーションの設計、検証、試験、(3) お客様のアプリケーションに該当する各種規格や、その他のあらゆる安全性、セキュリティ、規制、または他の要件への確実な適合に関する責任を、お客様のみが単独で負うものとします。

上記の各種リソースは、予告なく変更される可能性があります。これらのリソースは、リソースで説明されている TI 製品を使用するアプリケーションの開発の目的でのみ、TI はその使用をお客様に許諾します。これらのリソースに関して、他の目的で複製することや掲載することは禁止されています。TI や第三者の知的財産権のライセンスが付与されている訳ではありません。お客様は、これらのリソースを自身で使用した結果発生するあらゆる申し立て、損害、費用、損失、責任について、TI およびその代理人を完全に補償するものとし、TI は一切の責任を拒否します。

TIの製品は、TIの販売条件、TIの総合的な品質ガイドライン、 ti.com または TI 製品などに関連して提供される他の適用条件に従い提供されます。TI がこれらのリソースを提供することは、適用される TI の保証または他の保証の放棄の拡大や変更を意味するものではありません。 TI がカスタム、またはカスタマー仕様として明示的に指定していない限り、TI の製品は標準的なカタログに掲載される汎用機器です。

お客様がいかなる追加条項または代替条項を提案する場合も、TIはそれらに異議を唱え、拒否します。

Copyright © 2025, Texas Instruments Incorporated

最終更新日: 2025 年 10 月